Unit: mm

TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type

# SSM3J314T

### High Speed Switching Applications

• 4.0V drive

• Low ON-resistance:  $R_{on} = 100 \text{m}\Omega \text{ (max) (@V_{GS} = -4.0 V)}$ 

 $R_{on} = 54m\Omega \text{ (max) } (@V_{GS} = -10 \text{ V})$ 

# Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		$V_{DSS}$	-30	V	
Gate-Source voltage		V <sub>GSS</sub>	± 20	V	
Drain current	DC	I <sub>D</sub>	- 3.5	Α	
	Pulse	I <sub>DP</sub>	- 7.0		
Drain power dissipation		P <sub>D</sub> (Note 1)	700	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{mm}, \text{Cu Pad: } 645 \text{ mm}^2)$ 

# 1.Gate 2.Source 3.Drain

2-3S1A

Weight: 10 mg (typ.)

**JEDEC** 

JEITA

**TOSHIBA** 

### **Electrical Characteristics (Ta = 25°C)**

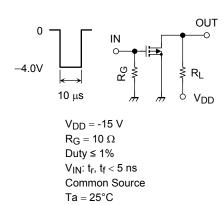
Char	acteristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	I <sub>D</sub> = - 1 mA, V <sub>GS</sub> = 0 V	-30	_	_	V
		V (BR) DSX	I <sub>D</sub> = - 1 mA, V <sub>GS</sub> = 20 V	-15	_	_	
Drain cut-off curre	ent	I <sub>DSS</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V	_	—	-10	μА
Gate leakage curi	rent	I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	—	±1	μА
Gate threshold vo	oltage	V <sub>th</sub>	V <sub>DS</sub> = - 5 V, I <sub>D</sub> = - 1 mA	-0.8	—	-2.0	V
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = -5 \text{ V}, I_D = -2.0 \text{ A}$ (Note:	2) 3.7	7.4		S
Drain-source ON-resistance		R <sub>DS</sub> (ON)	I <sub>D</sub> = - 2.0 A, V <sub>GS</sub> = - 10 V (Note:	2) —	38	54	mΩ
			I <sub>D</sub> = - 2.0 A, V <sub>GS</sub> = - 4.0 V (Note:	2) —	69	100	
Input capacitance	<b>!</b>	C <sub>iss</sub>			505	_	pF
Output capacitance		Coss	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	138		
Reverse transfer capacitance		C <sub>rss</sub>		_	105	—	
Total Gate Charge		Qg		_	11.5	_	nC
Gate-Source Charge		Qgs	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 3.5 A		8.9	_	
Gate-Drain Charge		Q <sub>gd</sub>	V <sub>GS</sub> = - 10 V	_	2.6	_	
Switching time	Turn-on time	t <sub>on</sub>	V <sub>DD</sub> = - 15 V, I <sub>D</sub> = - 1.0 A,	_	20	_	
	Turn-off time	t <sub>off</sub>	$V_{GS} = 0$ to - 4.0 V, $R_G = 10 \Omega$	_	20		ns
Drain-Source forward voltage		$V_{DSF}$	$I_D = 3.5 \text{ A}, V_{GS} = 0 \text{ V}$ (Note	2) —	0.8	1.2	V

Note2: Pulse test

Start of commercial production 2007-03

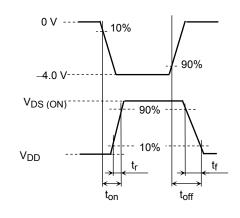
### **Switching Time Test Circuit**

### (a) Test Circuit

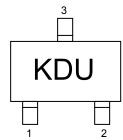


### (b) V<sub>IN</sub>

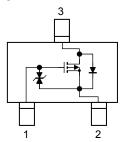
(c) Vout



# Marking



## **Equivalent Circuit (top view)**



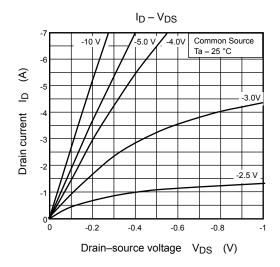
### **Notice on Usage**

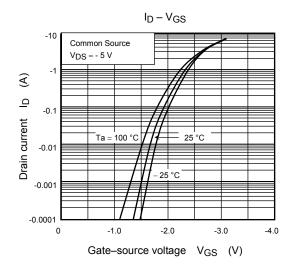
 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D$  = -1 mA for this product. For normal switching operation,  $V_{GS}$  (on) requires a higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires a lower voltage than  $V_{th}$ . (The relationship can be established as follows:  $V_{GS}$  (off) <  $V_{th}$  <  $V_{GS}$  (on).)

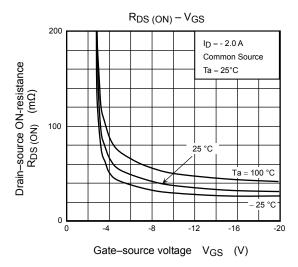
Take this into consideration when using the device.

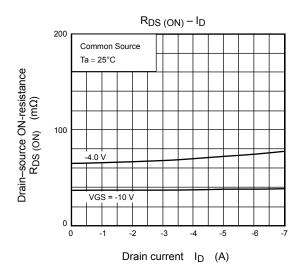
### **Handling Precaution**

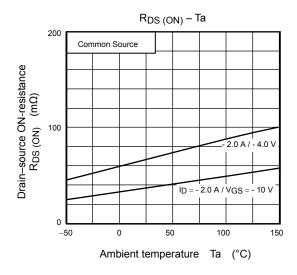
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials

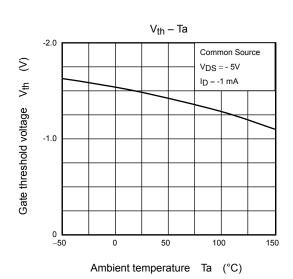


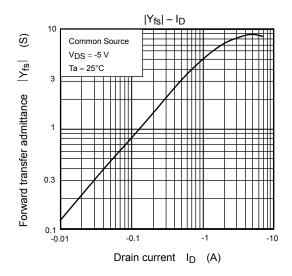


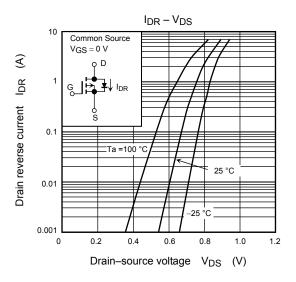


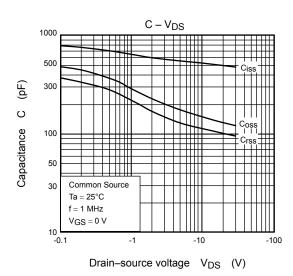


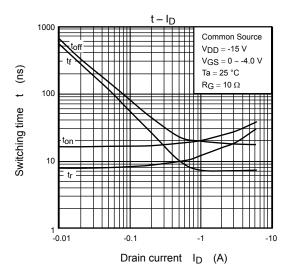


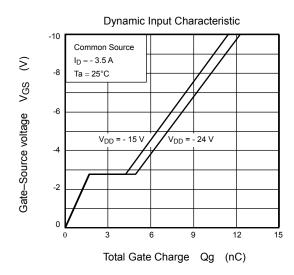




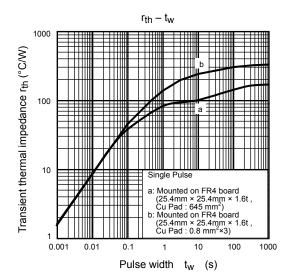


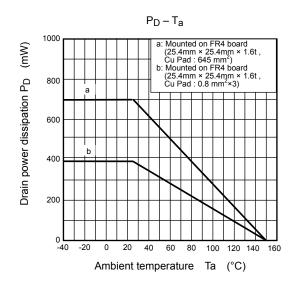






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